

C8729 (H)

Conductor

Description

C8729 (H) is a plateable silver conductor. It exhibits high adhesion. C8729 (H) is an excellent choice for plating applications, such as copper, nickel, etc.

Key Features

- Low resistivity
- High adhesion
- High speed printing
- Feed through hole application



This picture does not show the packaging of C8729 (H) and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.

Typical Properties

Viscosity	15-25 Pas (25 °C, D = 100/s)
Alloy Ratio	100
Metal	Ag

Recommended Processing Guide

Process Temperature (TDS)	Fire at 850 °C (peak) for 10-12 minutes, and with a total firing cycle time of c. 30-60 minutes.
Film Thickness	10-15 um

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